

ABSTRACT OF THE DISCLOSURE

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DEVICE FOR PROTECTION AGAINST ELECTROSTATIC DISCHARGES
FOR MICROELECTRONIC COMPONENTS ON SOI TYPE SUBSTRATE

The invention relates to a device (25) for protection of an electronic component against electrostatic discharges, the device (25) being made in a semiconducting layer of a substrate, the device being connected to a contact pin (21 to 24) to protect the said component in order to divert an electrostatic discharge, characterized in that the device (25) comprises at least one Zener diode connected to the said pin to be directly polarized.

Fig. 4

DEPOSITED DRAWING